





SURFACE MOUNT FAST SWITCHING DIODE

Features

- · Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Leads: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208⁽³⁾
- Polarity: Cathode Band
- Weight: 0.004 grams (Approximate)

SOD323



Top View

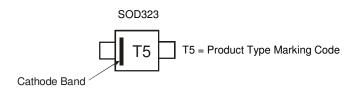
Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
1N4448WS-7-F	Standard	SOD323	3,000/Tape & Reel
1N4448WSQ-7-F	Automotive	SOD323	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





Maximum Ratings (@T_A = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	75	٧
RMS Reverse Voltage	V _{R(RMS)}	53	V
Forward Continuous Current	I _{FM}	500	mA
Average Rectified Output Current	Io	250	mA
Non-Repetitive Peak Forward Surge Current @t = 1.0 @t = 1.0	. I I I I I I I I I I I I I I I I I I I	4 0.5	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 7)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	∞

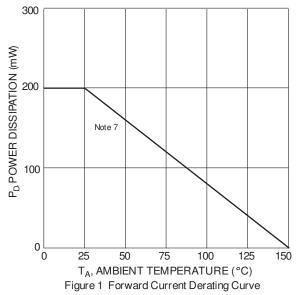
Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

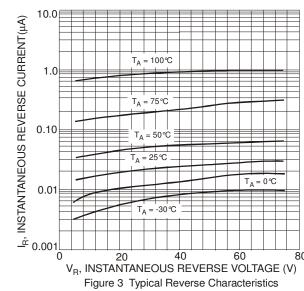
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	75	_	V	$I_R = 2.5\mu A$
		0.62	0.72		I _F = 5.0mA
Forward Voltage	V	_	0.855	V	$I_F = 10mA$
Forward voilage	V _{FM}		1.0	V	$I_F = 100 \text{mA}$
			1.25		I _F = 150mA
Peak Reverse Current (Note 6)	I _{RM}	_	2.5 50 30 25	μΑ μΑ μΑ nA	$V_R = 75V$ $V_R = 75V$, $T_J = +150$ °C $V_R = 25V$, $T_J = +150$ °C $V_R = 20V$
Total Capacitance	Ст	_	4.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	_	4.0	ns	$\begin{split} I_F &= I_R = 10 \text{mA}, \\ I_{rr} &= 0.1 \text{ x } I_R, \ R_L = 100 \Omega \end{split}$

Notes:

Short duration pulse test used to minimize self-heating.
 Part mounted on FR-4 PC board with minimum recommended pad layouts, which can be found on our website http://www.diodes.com/datasheets/ap02001.pdf.







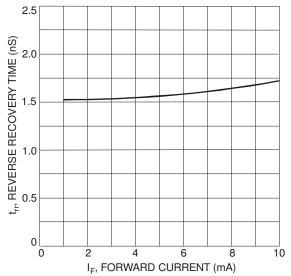
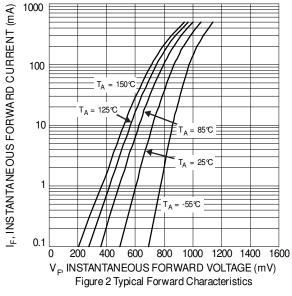
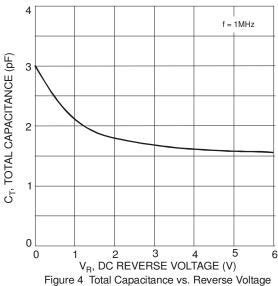


Figure 5 Reverse Recovery Time vs. Forward Current



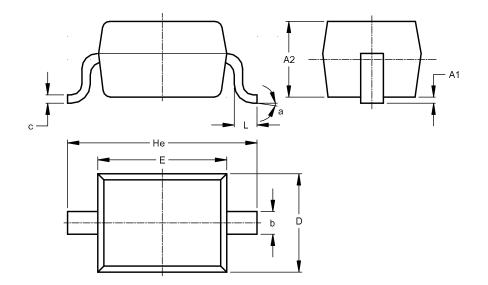


1N4448WS Document number: DS30096 Rev. 14 - 2



Package Outline Dimensions

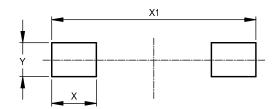
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOD323				
Dim	Min	Max	Тур	
A 1		0.10	0.05	
A2	1.00	1.10	1.05	
b	0.25	0.35	0.30	
C	0.10	0.15	0.11	
D	1.20	1.40	1.30	
Е	1.60	1.80	1.70	
He	2.30	2.70	2.50	
L	0.20	0.40	0.30	
а	ı 8°			
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Х	0.590		
X1	2.700		
Υ	0.450		



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